

**ADDENDUM TO THE BOARD OF REGENTS LOUISIANA MATERIALS DESIGN
ALLIANCE (LAMDA) SEED FUNDING TRACK 2: INDUSTRIAL
COLLABORATIONS AWARD FY 23-24 REQUEST FOR PROPOSALS**

Due to extensive delays resulting from fiscal year end, the deadline for submission of proposals to the LAMDA Seed Funding Track 2: Industrial Collaborations Award has been changed from Friday, July 7, 2023, at 4:30 p.m. Central to **Monday, July 17, 2023, at 4:30 p.m. Central**. All other requirements contained in the RFP remain as previously published. The affected sections of the RFP are cited below, with the revised deadline noted in red.

DEADLINE DATES:

RFP ISSUE DATE: (**May 5, 2023**)

Last day for questions and answers about this RFP: (**June 19, 2023**)

Proposals due: (July 17, 2023, 4:30 PM Central Time)

Schedule

Request for Proposals Released May 5, 2023

Last Day for Q&A June 19, 2023

Proposals Due July 17, 2023

Award Notification August 1, 2023

Project Dates August 15, 2023 – August 14, 2024

Proposal Submission

The proposal must be submitted by the PI to the Board of Regents through the LA EPSCoR online submission system, <https://laepscor.piestar-rfx.com/opportunities>, no later than the close of business day (4:30 p.m.) on **Monday, July 17, 2023**. All proposals must include a certification letter that the proposal has been approved by the submitting institution's authorized representative, see requirement in the Proposal Format section above.